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Details

Product Status	Active
Core Processor	12V1
Core Size	16-Bit
Speed	25MHz
Connectivity	IrDA, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	26
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3.13V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/s9s12gn32f1vlc

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		<lowest< th=""><th>Function PRIORITY</th><th>Power</th><th colspan="2">Internal Pull Resistor</th></lowest<>	Function PRIORITY	Power	Internal Pull Resistor			
Package Pin	Pin	2nd Func.	3rd Func.	4th Func	5th Func	Supply	CTRL	Reset State
57	PS5	MOSI0	—	—	—	V _{DDX}	PERS/PPSS	Up
58	PS6	SCK0	—	—	—	V _{DDX}	PERS/PPSS	Up
59	PS7	API_EXTC LK	ECLK	SS0	—	V _{DDX}	PERS/PPSS	Up
60	PM0	RXCAN	—	—	—	V _{DDX}	PERM/PPSM	Disabled
61	PM1	TXCAN	—	—	—	V _{DDX}	PERM/PPSM	Disabled
62	PM2	—	—	—	—	V _{DDX}	PERM/PPSM	Disabled
63	PM3	—	—		—	V _{DDX}	PERM/PPSM	Disabled
64	PJ7	KWJ7	_	_	_	V _{DDX}	PERJ/PPSJ	Up

¹ The regular I/O characteristics (see Section A.2, "I/O Characteristics") apply if the EXTAL/XTAL function is disabled

1.8.6 S12G96 and S12G128

1.8.6.1 Pinout 48-Pin LQFP





Table 1-20. 48-Pin LQFP Pinout for S12G96 and S12G12
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	Function <lowestpriorityhighest></lowestpriorityhighest>						Internal P Resisto	ull r
Package Pin	Pin	2nd Func.	3rd Func.	4th Func	5th Func	Supply	CTRL	Reset State
1	RESET	_	_	_	_	V _{DDX}	PULLUF)

1.8.8.3 Pinout 100-Pin LQFP



Figure 1-23. 100-Pin LQFP Pinout for S12G192 and S12G240

PAD5	 32 LQFP: The ACMPO signal of the analog comparator is mapped to this pin when used with the ACMP function. If the ACMP output is enabled (ACMPC[ACOPE]=1) the I/O state will be forced to output. 20 TSSOP: The inverting input signal ACMPM of the analog comparator is mapped to this pin when used with the ACMP function. The ACMP function has no effect on the output state. Refer to NOTE/2-172 for input buffer control. The ADC analog input channel signal AN5 and the related digital trigger input are mapped to this pin. The ADC function has no effect on the output state. Refer to NOTE/2-172 for input buffer control. 20 TSSOP: The SCI0 TXD signal is mapped to this pin. If the SCI0 TXD signal is enabled the I/O state will depend on the SCI0 configuration. 20 TSSOP: The TIM channel 3 signal is mapped to this pin. The TIM forces the I/O state to be an output for a timer port associated with an enabled output compare. 20 TSSOP: The PWM channel 3 signal is mapped to this pin. If the PWM channel is enabled and routed here the I/O state is forced to output. 20 TSSOP: The ADC ETRIG3 signal is mapped to this pin if PWM channel 3 is routed here. The enabled external trigger function has no effect on the I/O state. Refer to Section 2.6.4, "ADC External Triggers ETRIG3-0". Pin interrupts can be generated if enabled in digital input or output mode. Signal priority: 32 LQFP: ACMPO > GPO 20 TSSOP: TXD0 > IOC3 > PWM3 > GPO Others: GPO
PAD4	 20 TSSOP: The non-inverting input signal ACMPP of the analog comparator is mapped to this pin when used with the ACMP function. The ACMP function has no effect on the output state. Refer to NOTE/2-172 for input buffer control. The ADC analog input channel signal AN4 and the related digital trigger input are mapped to this pin. The ADC function has no effect on the output state. Refer to NOTE/2-172 for input buffer control. 20 TSSOP: The SCI0 RXD signal is mapped to this pin. If the SCI0 RXD signal is enabled and routed here the I/O state will be forced to input. 20 TSSOP: The TIM channel 2 signal is mapped to this pin. The TIM forces the I/O state to be an output for a timer port associated with an enabled output compare. 20 TSSOP: The PWM channel 2 signal is mapped to this pin. If the PWM channel is enabled and routed here the I/O state is forced to output. 20 TSSOP: The ADC ETRIG2 signal is mapped to this pin if PWM channel 2 is routed here. The enabled external trigger function has no effect on the I/O state. Refer to Section 2.6.4, "ADC External Triggers ETRIG3-0". Pin interrupts can be generated if enabled in digital input or output mode. Signal priority: 20 TSSOP: RXD0 > IOC2 > PWM2 > GPO Others: GPO

Port Integration Module (S12GPIMV1)

Global Address Register Name		Bit 7	6	5	4	3	2	1	Bit 0
0x026D PPSJ	R W	0	0	0	0	PPSJ3	PPSJ2	PPSJ1	PPSJ0
0x026E PIEJ	R W	0	0	0	0	PIEJ3	PIEJ2	PIEJ1	PIEJ0
0x026F PIFJ	R W	0	0	0	0	PIFJ3	PIFJ2	PIFJ1	PIFJ0
0x0270 PT0AD	R W	0	0	0	0	PT0AD3	PT0AD2	PT0AD1	PT0AD0
0x0271 PT1AD	R W	PT1AD7	PT1AD6	PT1AD5	PT1AD4	PT1AD3	PT1AD2	PT1AD1	PT1AD0
0x0272 PTI0AD	R W	0	0	0	0	PTI0AD3	PTI0AD2	PTI0AD1	PTI0AD0
0x0273 PTI1AD	R W	PTI1AD7	PTI1AD6	PTI1AD5	PTI1AD4	PTI1AD3	PTI1AD2	PTI1AD1	PTI1AD0
0x0274 DDR0AD	R W	0	0	0	0	DDR0AD3	DDR0AD2	DDR0AD1	DDR0AD0
0x0275 DDR1AD	R W	DDR1AD7	DDR1AD6	DDR1AD5	DDR1AD4	DDR1AD3	DDR1AD2	DDR1AD1	DDR1AD0
0x0276 Reserved	R W	0	0	0	0	0	0	0	0
0x0277 Reserved	R W	0	0	0	0	0	0	0	0
0x0278 PER0AD	R W	0	0	0	0	PER0AD3	PER0AD2	PER0AD1	PER0AD0
0x0279 PER1AD	R W	PER1AD7	PER1AD6	PER1AD5	PER1AD4	PER1AD3	PER1AD2	PER1AD1	PER1AD0
0x027A PPS0AD	R W	0	0	0	0	PPS0AD3	PPS0AD2	PPS0AD1	PPS0AD0
0x027B PPS1AD	R W	PPS1AD7	PPS1AD6	PPS1AD5	PPS1AD4	PPS1AD3	PPS1AD2	PPS1AD1	PPS1AD0
			= Unimplem	nented or Re	served				

Table 2-21. Block Register Map (G3) (continued)

Field	Description
7-0 PPSS	 Port S pull device select—Configure pull device polarity on input pin This bit selects a pullup or a pulldown device if enabled on the associated port input pin. 1 Pulldown device selected 0 Pullup device selected

2.4.3.25 Port S Wired-Or Mode Register (WOMS)

Address 0x024E

Access: User read/write1

	7	6	5	4	3	2	1	0
R W	WOMS7	WOMS6	WOMS5	WOMS4	WOMS3	WOMS2	WOMS1	WOMS0
Reset	0	0	0	0	0	0	0	0

Figure 2-26. Port S Wired-Or Mode Register (WOMS)

¹ Read: Anytime

Write: Anytime

Table 2-45. WOMS Register Field Descriptions

Field	Description
7-0 WOMS	 Port S wired-or mode—Enable open-drain functionality on output pin This bit configures an output pin as wired-or (open-drain) or push-pull. In wired-or mode a logic "0" is driven active-low while a logic "1" remains undriven. This allows a multipoint connection of several serial modules. The bit has no influence on pins used as input. 1 Output buffer operates as open-drain output. 0 Output buffer operates as push-pull output.

2.4.3.26 Pin Routing Register 0 (PRR0)

NOTE

Routing takes only effect if PKGCR is set to select the 20 TSSOP package.



2.5.2.6 Wired-Or Mode Register (WOMx)

If the pin is used as an output this register turns off the active-high drive. This allows wired-or type connections of outputs.

2.5.2.7 Interrupt Enable Register (PIEx)

If the pin is used as an interrupt input this register serves as a mask to the interrupt flag to enable/disable the interrupt.

2.5.2.8 Interrupt Flag Register (PIFx)

If the pin is used as an interrupt input this register holds the interrupt flag after a valid pin event.

2.5.2.9 Pin Routing Register (PRRx)

This register allows software re-configuration of the pinouts for specific peripherals in the 20 TSSOP package only.

2.5.2.10 Package Code Register (PKGCR)

This register determines the package in use. Pre programmed by factory.

2.5.3 Pin Configuration Summary

The following table summarizes the effect of the various configuration bits, that is data direction (DDR), output level (IO), pull enable (PE), pull select (PS) on the pin function and pull device ¹.

The configuration bit PS is used for two purposes:

- 1. Configure the sensitive interrupt edge (rising or falling), if interrupt is enabled.
- 2. Select either a pullup or pulldown device if PE is active.

^{1.}

S12S Debug Module (S12SDBGV2)

event B cause a trigger. Similarly 2 consecutive occurrences of event B without an intermediate event A cause a trigger. This is possible by using CompA and CompC to match on the same address as shown.





This scenario is currently not possible using 2 comparators only. S12SDBGV2 makes it possible with 2 comparators, State 3 allowing a M0 to return to state 2, whilst a M2 leads to final state as shown.





The advantage of using only 2 channels is that now range comparisons can be included (channel0)

This however violates the S12SDBGV1 specification, which states that a match leading to final state always has priority in case of a simultaneous match, whilst priority is also given to the lowest channel number. For S12SDBG the corresponding CPU priority decoder is removed to support this, such that on simultaneous taghits, taghits pointing to final state have highest priority. If no taghit points to final state then the lowest channel number has priority. Thus with the above encoding from State3, the CPU and DBG would break on a simultaneous M0/M2.

Field	Description
7 PLLSEL	PLL Select Bit This bit selects the PLLCLK as source of the System Clocks (Core Clock and Bus Clock). PLLSEL can only be set to 0, if UPOSC=1. UPOSC= 0 sets the PLLSEL bit. Entering Full Stop Mode sets the PLLSEL bit. 0 System clocks are derived from OSCCLK if oscillator is up (UPOSC=1, $f_{bus} = f_{osc} / 2$. 1 System clocks are derived from PLLCLK, $f_{bus} = f_{PLL} / 2$.
6 PSTP	 Pseudo Stop Bit This bit controls the functionality of the oscillator during Stop Mode. O Socillator is disabled in Stop Mode (Full Stop Mode). 1 Oscillator continues to run in Stop Mode (Pseudo Stop Mode), option to run RTI and COP. Note: Pseudo Stop Mode allows for faster STOP recovery and reduces the mechanical stress and aging of the resonator in case of frequent STOP conditions at the expense of a slightly increased power consumption. Note: When starting up the external oscillator (either by programming OSCE bit to 1 or on exit from Full Stop Mode with OSCE bit is already 1) the software must wait for a minimum time equivalent to the startup-time of the external oscillator t_{UPOSC} before entering Pseudo Stop Mode.
4 COP OSCSEL1	COP Clock Select 1 — COPOSCSEL0 and COPOSCSEL1 combined determine the clock source to the COP (see also Table 10-6). If COPOSCSEL1 = 1, COPOSCSEL0 has no effect regarding clock select and changing the COPOSCSEL0 bit does not re-start the COP time-out period. COPOSCSEL1 selects the clock source to the COP to be either ACLK (derived from trimmable internal RC-Oscillator) or clock selected via COPOSCSEL0 (IRCCLK or OSCCLK). Changing the COPOSCSEL1 bit re-starts the COP time-out period. COPOSCSEL1 can be set independent from value of UPOSC. UPOSC= 0 does not clear the COPOSCSEL0 bit. 0 COP clock source defined by COPOSCSEL0 1 COP clock source is ACLK derived from a trimmable internal RC-Oscillator
3 PRE	 RTI Enable During Pseudo Stop Bit — PRE enables the RTI during Pseudo Stop Mode. 0 RTI stops running during Pseudo Stop Mode. 1 RTI continues running during Pseudo Stop Mode if RTIOSCSEL=1. Note: If PRE=0 or RTIOSCSEL=0 then the RTI will go static while Stop Mode is active. The RTI counter will not be reset.
2 PCE	 COP Enable During Pseudo Stop Bit — PCE enables the COP during Pseudo Stop Mode. 0 COP stops running during Pseudo Stop Mode if: COPOSCSEL1=0 and COPOSCSEL0=0 1 COP continues running during Pseudo Stop Mode if: PSTP=1, COPOSCSEL1=0 and COPOSCSEL0=1 Note: If PCE=0 or COPOSCSEL0=0 while COPOSCSEL1=0 then the COP is static during Stop Mode being active. The COP counter will <u>not</u> be reset.

S12 Clock, Reset and Power Management Unit (S12CPMU)

10.6 Interrupts

The interrupt/reset vectors requested by the S12CPMU are listed in Table 10-29. Refer to MCU specification for related vector addresses and priorities.

Interrupt Source	CCR Mask	Local Enable
RTI time-out interrupt	I bit	CPMUINT (RTIE)
PLL lock interrupt	I bit	CPMUINT (LOCKIE)
Oscillator status interrupt	l bit	CPMUINT (OSCIE)
Low voltage interrupt	I bit	CPMULVCTL (LVIE)
Autonomous Periodical Interrupt	l bit	CPMUAPICTL (APIE)

Table 10-29. S12CPMU Interrupt Vectors

10.6.1 Description of Interrupt Operation

10.6.1.1 Real Time Interrupt (RTI)

The clock source for the RTI is either IRCCLK or OSCCLK depending on the setting of the RTIOSCSEL bit. In Stop Mode with PSTP=1 (Pseudo Stop Mode), RTIOSCSEL=1 and PRE=1 the RTI continues to run, else the RTI counter halts in Stop Mode.

The RTI can be used to generate hardware interrupts at a fixed periodic rate. If enabled (by setting RTIE=1), this interrupt will occur at the rate selected by the CPMURTI register. At the end of the RTI time-out period the RTIF flag is set to one and a new RTI time-out period starts immediately.

A write to the CPMURTI register restarts the RTI time-out period.

10.6.1.2 PLL Lock Interrupt

The S12CPMU generates a PLL Lock interrupt when the lock condition (LOCK status bit) of the PLL changes, either from a locked state to an unlocked state or vice versa. Lock interrupts are locally disabled by setting the LOCKIE bit to zero. The PLL Lock interrupt flag (LOCKIF) is set to 1 when the lock condition has changed, and is cleared to 0 by writing a 1 to the LOCKIF bit.

10.6.1.3 Oscillator Status Interrupt

When the OSCE bit is 0, then UPOSC stays 0. When OSCE = 1 the UPOSC bit is set after the LOCK bit is set.

Upon detection of a status change (UPOSC) the OSCIF flag is set. Going into Full Stop Mode or disabling the oscillator can also cause a status change of UPOSC.

11.3.2.6 ATD Control Register 5 (ATDCTL5)

Writes to this register will abort current conversion sequence and start a new conversion sequence. If the external trigger function is enabled (ETRIGE=1) an initial write to ATDCTL5 is required to allow starting of a conversion sequence which will then occur on each trigger event. Start of conversion means the beginning of the sampling phase.

Module Base + 0x0005



Figure 11-8. ATD Control Register 5 (ATDCTL5)

Read: Anytime

Write: Anytime

Table 11-14. ATDCTL5 Field Descriptions

Field	Description
6 SC	 Special Channel Conversion Bit — If this bit is set, then special channel conversion can be selected using CD, CC, CB and CA of ATDCTL5. Table 11-15 lists the coding. O Special channel conversions disabled 1 Special channel conversions enabled
5 SCAN	 Continuous Conversion Sequence Mode — This bit selects whether conversion sequences are performed continuously or only once. If the external trigger function is enabled (ETRIGE=1) setting this bit has no effect, thus the external trigger always starts a single conversion sequence. 0 Single conversion sequence 1 Continuous conversion sequences (scan mode)
4 MULT	Multi-Channel Sample Mode — When MULT is 0, the ATD sequence controller samples only from the specified analog input channel for an entire conversion sequence. The analog channel is selected by channel selection code (control bits CD/CC/CB/CA located in ATDCTL5). When MULT is 1, the ATD sequence controller samples across channels. The number of channels sampled is determined by the sequence length value (S8C, S4C, S2C, S1C). The first analog channel examined is determined by channel selection code (CD, CC, CB, CA control bits); subsequent channels sampled in the sequence are determined by incrementing the channel selection code or wrapping around to AN0 (channel 0).
3–0 CD, CC, CB, CA	Analog Input Channel Select Code — These bits select the analog input channel(s). Table 11-15 lists the coding used to select the various analog input channels.
	In the case of single channel conversions (MULT=0), this selection code specifies the channel to be examined.
	In the case of multiple channel conversions (MULT=1), this selection code specifies the first channel to be examined in the conversion sequence. Subsequent channels are determined by incrementing the channel selection code or wrapping around to AN0 (after converting the channel defined by the Wrap Around Channel Select Bits WRAP3-0 in ATDCTL0). When starting with a channel number higher than the one defined by WRAP3-0 the first wrap around will be AN7 to AN0.

Scalable Controller Area Network (S12MSCANV3)

Field	Description
1 SLPAK	 Sleep Mode Acknowledge — This flag indicates whether the MSCAN module has entered sleep mode (see Section 18.4.5.5, "MSCAN Sleep Mode"). It is used as a handshake flag for the SLPRQ sleep mode request. Sleep mode is active when SLPRQ = 1 and SLPAK = 1. Depending on the setting of WUPE, the MSCAN will clear the flag if it detects activity on the CAN bus while in sleep mode. 0 Running — The MSCAN operates normally 1 Sleep mode active — The MSCAN has entered sleep mode
0 INITAK	Initialization Mode Acknowledge — This flag indicates whether the MSCAN module is in initialization mode (see Section 18.4.4.5, "MSCAN Initialization Mode"). It is used as a handshake flag for the INITRQ initialization mode request. Initialization mode is active when INITRQ = 1 and INITAK = 1. The registers CANCTL1, CANBTR0, CANBTR1, CANIDAC, CANIDAR0–CANIDAR7, and CANIDMR0–CANIDMR7 can be written only by the CPU when the MSCAN is in initialization mode. 0 Running — The MSCAN operates normally 1 Initialization mode active — The MSCAN has entered initialization mode

Table 18-4. CANCTL1 Register Field Descriptions (continued)

18.3.2.3 MSCAN Bus Timing Register 0 (CANBTR0)

The CANBTR0 register configures various CAN bus timing parameters of the MSCAN module.

Module Base + 0x0002

Access: User read/write¹

	7	6	5	4	3	2	1	0	
R W	SJW1	SJW0	BRP5	BRP4	BRP3	BRP2	BRP1	BRP0	
Reset:	0	0	0	0	0	0	0	0	

Figure 18-6. MSCAN Bus Timing Register 0 (CANBTR0)

¹ Read: Anytime

Write: Anytime in initialization mode (INITRQ = 1 and INITAK = 1)

Table 18-5. CANBTR0 Register Field Descriptions

Field	Description
7-6 SJW[1:0]	Synchronization Jump Width — The synchronization jump width defines the maximum number of time quanta (Tq) clock cycles a bit can be shortened or lengthened to achieve resynchronization to data transitions on the CAN bus (see Table 18-6).
5-0 BRP[5:0]	Baud Rate Prescaler — These bits determine the time quanta (Tq) clock which is used to build up the bit timing (see Table 18-7).

Table 18-6. Synchronization Jump Width

SJW1	SJW0	Synchronization Jump Width
0	0	1 Tq clock cycle
0	1	2 Tq clock cycles
1	0	3 Tq clock cycles
1	1	4 Tq clock cycles

18.4.4.2 Special System Operating Modes

The MSCAN module behaves as described within this specification in all special system operating modes. Write restrictions which exist on specific registers in normal modes are lifted for test purposes in special modes.

18.4.4.3 Emulation Modes

In all emulation modes, the MSCAN module behaves just like in normal system operating modes as described within this specification.

18.4.4.4 Listen-Only Mode

In an optional CAN bus monitoring mode (listen-only), the CAN node is able to receive valid data frames and valid remote frames, but it sends only "recessive" bits on the CAN bus. In addition, it cannot start a transmission.

If the MAC sub-layer is required to send a "dominant" bit (ACK bit, overload flag, or active error flag), the bit is rerouted internally so that the MAC sub-layer monitors this "dominant" bit, although the CAN bus may remain in recessive state externally.

18.4.4.5 MSCAN Initialization Mode

The MSCAN enters initialization mode when it is enabled (CANE=1).

When entering initialization mode during operation, any on-going transmission or reception is immediately aborted and synchronization to the CAN bus is lost, potentially causing CAN protocol violations. To protect the CAN bus system from fatal consequences of violations, the MSCAN immediately drives TXCAN into a recessive state.

NOTE

The user is responsible for ensuring that the MSCAN is not active when initialization mode is entered. The recommended procedure is to bring the MSCAN into sleep mode (SLPRQ = 1 and SLPAK = 1) before setting the INITRQ bit in the CANCTL0 register. Otherwise, the abort of an on-going message can cause an error condition and can impact other CAN bus devices.

In initialization mode, the MSCAN is stopped. However, interface registers remain accessible. This mode is used to reset the CANCTL0, CANRFLG, CANRIER, CANTFLG, CANTIER, CANTARQ, CANTAAK, and CANTBSEL registers to their default values. In addition, the MSCAN enables the configuration of the CANBTR0, CANBTR1 bit timing registers; CANIDAC; and the CANIDAR, CANIDMR message filters. See Section 18.3.2.1, "MSCAN Control Register 0 (CANCTL0)," for a detailed description of the initialization mode.

25.4.4.3 Valid Flash Module Commands

Table 25-27 present the valid Flash commands, as enabled by the combination of the functional MCU mode (Normal SingleChip NS, Special Singlechip SS) with the MCU security state (Unsecured, Secured).

Special Singlechip mode is selected by input mmc_ss_mode_ts2 asserted. MCU Secured state is selected by input mmc_secure input asserted.

FOND	Commond	Unse	cured	Secured	
FCMD	Command	NS ¹	SS ²	NS ³	SS ⁴
0x01	Erase Verify All Blocks	*	*	*	*
0x02	Erase Verify Block	*	*	*	*
0x03	Erase Verify P-Flash Section	*	*	*	
0x04	Read Once	*	*	*	
0x06	Program P-Flash	*	*	*	
0x07	Program Once	*	*	*	
0x08	Erase All Blocks		*		*
0x09	Erase Flash Block	*	*	*	
0x0A	Erase P-Flash Sector	*	*	*	
0x0B	Unsecure Flash		*		*
0x0C	Verify Backdoor Access Key	*		*	
0x0D	Set User Margin Level	*	*	*	
0x0E	Set Field Margin Level		*		
0x10	Erase Verify EEPROM Section	*	*	*	
0x11	Program EEPROM	*	*	*	
0x12	Erase EEPROM Sector	*	*	*	

Table 25-27. Flash Commands by Mode and Security State

¹ Unsecured Normal Single Chip mode

² Unsecured Special Single Chip mode.

³ Secured Normal Single Chip mode.

⁴ Secured Special Single Chip mode.

25.4.4.4 P-Flash Commands

Table 25-28 summarizes the valid P-Flash commands along with the effects of the commands on the P-Flash block and other resources within the Flash module.

FCMD	Command	Function on P-Flash Memory
0x01	Erase Verify All Blocks	Verify that all P-Flash (and EEPROM) blocks are erased.

 Table 25-28. P-Flash Commands

48 KByte Flash Module (S12FTMRG48K1V1)



Figure 26-26. Generic Flash Command Write Sequence Flowchart

128 KByte Flash Module (S12FTMRG128K1V1)

CCOBIX[2:0]	FCCOB Parameters	
000	0x09	Global address [17:16] to identify Flash block
001	Global address [15:0] in Flash block to be erased	

Table 29-46. Erase Flash Block Command FC	CCOB Requirements
---	-------------------

Upon clearing CCIF to launch the Erase Flash Block command, the Memory Controller will erase the selected Flash block and verify that it is erased. The CCIF flag will set after the Erase Flash Block operation has completed.

Register	Error Bit	Error Condition
		Set if CCOBIX[2:0] != 001 at command launch
		Set if command not available in current mode (see Table 29-27)
	ACCERR	Set if an invalid global address [17:16] is supplied
FSTAT		Set if the supplied P-Flash address is not phrase-aligned or if the EEPROM address is not word-aligned
	FPVIOL	Set if an area of the selected Flash block is protected
	MGSTAT1	Set if any errors have been encountered during the verify operation
	MGSTAT0	Set if any non-correctable errors have been encountered during the verify operation

Table 29-47. Erase Flash Block Command Error Handling

29.4.6.9 Erase P-Flash Sector Command

The Erase P-Flash Sector operation will erase all addresses in a P-Flash sector.

Table 29-48. Erase P-Flash Sector Command FCCOB Requirements

CCOBIX[2:0]	FCCOB Parameters				
000	0x0A	Global address [17:16] to identify P-Flash block to be erased			
001	Global address [15:0] anywhere within the sector to be erased. Refer to Section 29.1.2.1 for the P-Flash sector size.				

Upon clearing CCIF to launch the Erase P-Flash Sector command, the Memory Controller will erase the selected Flash sector and then verify that it is erased. The CCIF flag will be set after the Erase P-Flash Sector operation has completed.

Register	Error Bit	Error Condition
		Set if CCOBIX[2:0] < 010 at command launch
		Set if CCOBIX[2:0] > 101 at command launch
	ACCERR	Set if command not available in current mode (see Table 29-27)
		Set if an invalid global address [17:0] is supplied
FSTAT		Set if a misaligned word address is supplied (global address [0] != 0)
		Set if the requested group of words breaches the end of the EEPROM block
	FPVIOL	Set if the selected area of the EEPROM memory is protected
	MGSTAT1	Set if any errors have been encountered during the verify operation
	MGSTAT0	Set if any non-correctable errors have been encountered during the verify operation

Table 29-63. Program EEPROM Command Error Handling

29.4.6.16 Erase EEPROM Sector Command

The Erase EEPROM Sector operation will erase all addresses in a sector of the EEPROM block.

Table 29-64.	. Erase EEPROM	Sector Command	FCCOB Requirements
--------------	----------------	----------------	--------------------

CCOBIX[2:0]	FCCOB Parameters				
000	0x12	Global address [17:16] to identify EEPROM block			
001	Global address [15:0] anywhere within the sector to be erased. See Section 29.1.2.2 for EEPROM sector size.				

Upon clearing CCIF to launch the Erase EEPROM Sector command, the Memory Controller will erase the selected Flash sector and verify that it is erased. The CCIF flag will set after the Erase EEPROM Sector operation has completed.

Register	Error Bit	Error Condition					
		Set if CCOBIX[2:0] != 001 at command launch					
	ACCERR	Set if command not available in current mode (see Table 29-27)					
FSTAT		Set if an invalid global address [17:0] is supplied (see Table 29-3)					
		Set if a misaligned word address is supplied (global address [0] != 0)					
	FPVIOL	Set if the selected area of the EEPROM memory is protected					
	MGSTAT1	Set if any errors have been encountered during the verify operation					
	MGSTAT0	Set if any non-correctable errors have been encountered during the verify operation					

Table 29-65. Erase EEPROM Sector Command Error Handling

30.3.2 Register Descriptions

The Flash module contains a set of 20 control and status registers located between Flash module base + 0x0000 and 0x0013.

In the case of the writable registers, the write accesses are forbidden during Fash command execution (for more detail, see Caution note in Section 30.3).

A summary of the Flash module registers is given in Figure 30-4 with detailed descriptions in the following subsections.

Address & Name		7	6	5	4	3	2	1	0
0x0000 FCLKDIV	R W	FDIVLD	FDIVLCK	FDIV5	FDIV4	FDIV3	FDIV2	FDIV1	FDIV0
0x0001 FSEC	R W	KEYEN1	KEYEN0	RNV5	RNV4	RNV3	RNV2	SEC1	SEC0
0x0002 FCCOBIX	R W	0	0	0	0	0	CCOBIX2	CCOBIX1	CCOBIX0
0x0003 FRSV0	R W	0	0	0	0	0	0	0	0
0x0004 FCNFG	R W	CCIE	0	0	IGNSF	0	0	FDFD	FSFD
0x0005 FERCNFG	R W	0	0	0	0	0	0	DFDIE	SFDIE
0x0006 FSTAT	R W	CCIF	0	ACCERR	FPVIOL	MGBUSY	RSVD	MGSTAT1	MGSTAT0
0x0007 FERSTAT	R W	0	0	0	0	0	0	DFDIF	SFDIF
0x0008 FPROT	R W	FPOPEN	RNV6	FPHDIS	FPHS1	FPHS0	FPLDIS	FPLS1	FPLS0
0x0009 EEPROT	R W	DPOPEN	DPS6	DPS5	DPS4	DPS3	DPS2	DPS1	DPS0

Figure 30-4. FTMRG192K2 Register Summary

• VERNUM: Version number. The first version is number 0b_0001 with both 0b_0000 and 0b_1111 meaning 'none'.

30.4.3 Internal NVM resource (NVMRES)

IFR is an internal NVM resource readable by CPU, when NVMRES is active. The IFR fields are shown in Table 30-5.

The NVMRES global address map is shown in Table 30-6.

30.4.4 Flash Command Operations

Flash command operations are used to modify Flash memory contents.

The next sections describe:

- How to write the FCLKDIV register that is used to generate a time base (FCLK) derived from BUSCLK for Flash program and erase command operations
- The command write sequence used to set Flash command parameters and launch execution
- Valid Flash commands available for execution, according to MCU functional mode and MCU security state.

30.4.4.1 Writing the FCLKDIV Register

Prior to issuing any Flash program or erase command after a reset, the user is required to write the FCLKDIV register to divide BUSCLK down to a target FCLK of 1 MHz. Table 30-8 shows recommended values for the FDIV field based on BUSCLK frequency.

NOTE

Programming or erasing the Flash memory cannot be performed if the bus clock runs at less than 0.8 MHz. Setting FDIV too high can destroy the Flash memory due to overstress. Setting FDIV too low can result in incomplete programming or erasure of the Flash memory cells.

When the FCLKDIV register is written, the FDIVLD bit is set automatically. If the FDIVLD bit is 0, the FCLKDIV register has not been written since the last reset. If the FCLKDIV register has not been written, any Flash program or erase command loaded during a command write sequence will not execute and the ACCERR bit in the FSTAT register will set.

30.4.4.2 Command Write Sequence

The Memory Controller will launch all valid Flash commands entered using a command write sequence.

Before launching a command, the ACCERR and FPVIOL bits in the FSTAT register must be clear (see Section 30.3.2.7) and the CCIF flag should be tested to determine the status of the current command write sequence. If CCIF is 0, the previous command write sequence is still active, a new command write sequence cannot be started, and all writes to the FCCOB register are ignored.

31.3.2.9.1 P-Flash Protection Restrictions

The general guideline is that P-Flash protection can only be added and not removed. Table 31-21 specifies all valid transitions between P-Flash protection scenarios. Any attempt to write an invalid scenario to the FPROT register will be ignored. The contents of the FPROT register reflect the active protection scenario. See the FPHS and FPLS bit descriptions for additional restrictions.

From Protection Scenario	To Protection Scenario ¹							
	0	1	2	3	4	5	6	7
0	Х	Х	Х	Х				
1		Х		Х				
2			Х	Х				
3				Х				
4				Х	Х			
5			Х	Х	Х	Х		
6		Х		Х	Х		Х	
7	Х	Х	Х	Х	Х	Х	Х	Х

Table 31-21. P-Flash Protection Scenario Transitions

¹ Allowed transitions marked with X, see Figure 31-14 for a definition of the scenarios.

31.3.2.10 EEPROM Protection Register (EEPROT)

The EEPROT register defines which EEPROM sectors are protected against program and erase operations.



¹ Loaded from IFR Flash configuration field, during reset sequence.

The (unreserved) bits of the EEPROT register are writable with the restriction that protection can be added but not removed. Writes must increase the DPS value and the DPOPEN bit can only be written from 1 (protection disabled) to 0 (protection enabled). If the DPOPEN bit is set, the state of the DPS bits is irrelevant.

During the reset sequence, fields DPOPEN and DPS of the EEPROT register are loaded with the contents of the EEPROM protection byte in the Flash configuration field at global address 0x3_FF0D located in